

Material Composition Declaration

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This document is a declaration of the substances within the manufacturer listed item. Note: if the item is an assembly with lower level parts, the declaration encompasses all lower level materials for which the manufacturer has engineering responsibility.

1752-2 1.1

ICP Web Site for information on IPC-1752 Standard
<http://www.ipc.org/IPC-175x>

Form Type*
Distribute

Declaration Class*
Class 6 - RoHS Yes/No, Homogeneous Materials and Mfg Information

Supplier Information

Company Name * Fairchild Semiconductor	Company Unique ID 00-489-5751	Unique ID Authority Dun & Bradstreet	Response Date* Sat, May 19, 2012 02:27 AM
Contact Name * David Lancaster	Title - Contact Product Ecology	Phone - Contact * 801-562-7455	Email - Contact * david.lancaster@fairchildsemi.com
Authorized Representative * David Lancaster	Title - Representative Product Ecology	Phone - Representative * 801-562-7455	Email - Representative * david.lancaster@fairchildsemi.com

Requester Item Number	Mf Item Number	Mf Item Name	Effective Date	Version	Manufacturing Site	Weight*	UOM	Unit Type
CNY171SR2M	CNY171SR2M	SMDIPW-6			INTERNAL PENANG	0.465	g	Each

Manufacturing Process Information

Terminal Finish	Base Alloy	J-STD-020 MSL Rating	Peak Process Body Temperature	Max Time at Peak Temperature	No Reflow cycles
Matte Tin (Sn)	CU Alloy	1	260 C	30 seconds	3

* Required Field

RoHS Material Composition Declaration	Declaration Type * Custom
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RoHS Directive 2002/95/EC	RoHS Definition: Quantity limit of 0.1% by mass (1000 PPM) in homogeneous material for: Lead (Pb), Mercury, Hexavalent Chromium, Polybrominated Biphenyls (PBB), Polybrominated Diphenyl Ethers (PBDE) and quantity limit of 0.01% by mass (100 PPM) of homogeneous material for Cadmium
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Providing for limitations below, we certify that the Fairchild Semiconductor product(s) list in this document are compliant to directive 2002/95/EC of the European Parliament and of the council on the restriction of the use of certain hazardous substances in electrical and electronic equipment (RoHS directive). Specifically, this product(s) does not contain the substances in the RoHS definition above in concentrations greater than the maximum limit value(a).

Fairchild has implemented procedures to ensure our products and the materials in our products conform to regulatory requirements worldwide. Fairchild Semiconductor certifies that the information provided in this document is correct as of the date indicated on this document. However, not all materials in Fairchild's products may have been independently verified or tested with regard to substance content. In the event of any issues arising from information in this document, the warranty section of Fairchild's standard terms and conditions of sale shall apply, unless alternate contracts have been agreed upon in writing by both parties.

(a) Maximum limit does not apply to applications for which exemptions have been granted by the RoHS directive. Fairchild product may utilize exemption 5 and 7a.

RoHS Declaration *	1 - Item(s) does not contain RoHS restricted substances per the definition above	Supplier Acceptance * Accepted
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Exemptions: If the declared item does not contain RoHS restricted substances per the definition above except for defined RoHS exemptions, then select the corresponding response in the RoHS Declaration above and choose all applicable exemptions.

Exemption List Version EL-2006/690/EC 0
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Declaration Signature

Supplier Signature	 DAVID LANCASTER - PRODUCT ECOLOGY MANAGER
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Homogeneous Material Composition Declaration for Electronic Products

Item/SubItem Name SMDIPW-6

Component	Material	Weight (mg)	Jig Level	Substance Category	Substance	Weight (mg)	CAS	PPM
Chip	Other inorganic materials	5.130	Supplier		Silicon	5.130	7440-21-3	11035
Coupling Gel	Other Organic Materials	0.400	Supplier		Dimethyl Cyclosiloxanes	0.067	69430-24-6	145
			Supplier		Methyltrimethoxysilane	0.139	1185-55-3	299
			Supplier		Xylene	0.194	1330-20-7	417
Die Attach	Other Organic Materials	0.300	Supplier		Acrylic Resin	0.075	54208-63-8	161
			Supplier		Silver	0.225	7440-22-4	484
Encapsulation	Thermoplastics	327.220	B	Antimony/Antimony Compounds	Antimony Trioxide	9.820	1309-64-4	21123
			B	Brominated Flame Retardants (other than PBCs or PBDEs)	Bromine Resin	13.100	6386-73-8	28178
			Supplier		Epoxy Resin	75.300	29690-82-2	161969
			Supplier		Silica, vitreous	229.000	60676-86-0	492576
Lead Frame	Other Ferrous alloys, non-stainless steels	101.703	Supplier		Copper	98.300	7440-50-8	211442
			Supplier		Iron	2.640	7439-89-6	5679
			Supplier		Phosphorus	0.153	7723-14-0	329
			Supplier		Silver	0.407	7440-22-4	875
			Supplier		Zinc	0.203	7440-66-6	437
Plating	Other Nonferrous metals & alloys	28.500	Supplier		Tin	28.500	7440-31-5	61303
Wire Bond	Precious metals	1.650	Supplier		Gold	1.650	7440-57-5	3549